

Please see our DIY companion video and documentation on our website for more info:
<https://usbnes.com/usb-nes-lite-diy-kit/>

1. What you'll need:

- * USB-NES Lite parts kit (thank-you for your purchase)
- * USB-NES 3D print model
- * Filament 3D printer
- * Fine-tipped soldering iron + station + solder
- * Solder wick (optional; for removing solder bridges and excess solder)
- * "3rd Hand" PCB holder
- * Magnifying glass (optional; for inspecting solder joints)
- * Flat-tipped or electronics' tweezers
- * Lineman's pliers / needle-nose or similar type
- * #1 Phillips screwdriver
- * Utility knife
- * Flush cutters (optional)
- * Intermittent soldering skills
- * Patience and persistence (estimated 1 hour assembly time)

2. Open and Examine the USB-NES assembly kit:

- 1x Protective jewel case
- 1x STM32 barebones system "blue pill" board (preprogrammed with current USB-NES firmware)
- 1x 40-pin single-inline header
- 1x 4-pin single-inline header
- 1x 6-pin dual-inline header
- 1x thin jumper wire
- 1x Printed circuit board "USB-NES-01"
- 1x 72-pin NES cart connector
- 1x surface-mount 10k-ohm resistor
- 1x surface-mount P-channel power mosfet
- 1x surface-mount level shifter
- 1x 3ft. Micro-USB cord
- 4x #4-40 x 1" machine screws
- 2x #4-40 x 11/16" machine screws
- 1x 560 uF electrolytic capacitor

3. Prep the pin headers:

- * Break the 40-pin header into 2 equal sections of 20 pins.
- * Use pliers to straighten the 4-pin header
- * Use pliers again to slide the 4-pin header spacer down to be equal to that of the other 20 pin ones.
- * Remove and discard the 2 yellow jumpers from the 6-pin header.

4. Prep the blue pill board (Very Important!):

- * Remove and discard R4 from the board with the soldering iron by heating both sides of the surface mount resistor and pushing it away from the other components.
- * Tin one end of the thin jumper wire that came with the kit.
- * Use the thin jumper wire to bridge R4. Cut the excess wire off neatly with a knife.
- * (optional) Apply some extra solder on the 4 mounting holes for the micro-USB header to improve structural integrity.

5. Prep the USB-NES board with the surface mount parts:

- * Place a small amount of solder on a single pad within the part's footprint.
- * Use the tweezers to place the part on top the board oriented with the footprint; hold it steady.
- * Heat the soldered pad with the soldering iron while pressing the part against the board until the lead from the part makes a good bond with the solder.
- * Solder the rest of the leads of the part to the pads.
- * Repeat this process for all 3 surface mount parts.
- * Use a magnifying glass to inspect for good solder joints and identify any solder bridges on the surface mount parts (especially on the 5-lead level shifter chip).
- * Use solder wick to clean up any bridges or excess solder.

6. Stuff the pin headers into the USB-NES board:

- * Stuff the 2x 20-pin and 6-pin headers long-side-up into the topside through-holes of the blue pill footprint.
- * Make sure the header spacers are flush with the surface of the board.
- * Repeat all these same steps for the 4-pin header afterwards.
- * Use pliers or other means when inserting tight headers.

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